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Autore	Humphreys F. J
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Sommario/riassunto

Related Annealing Phenomena fulfills the information needs of materials scientists in both industry and academia. The subjects treated in the book are all active research areas, forming a major part of at least four regular international conference series. This new 2nd edition ensures the reader has access to the latest findings, essential to those working at the forefront of research in universities and laboratories. For those in industry, the book highlights applications of the research and technologically important examples. In particular, the 2nd edition builds on the significant pr
